

Excellent Integrated System Limited

Stocking Distributor

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<u>Vishay Semiconductor/Diodes Division</u> <u>VS-16EDH02HM3</u>

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Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite Datasheet of VS-16EDH02HM3 - DIODE GEN PURP 200V 16A TO263AC

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VS-16EDH02HM3

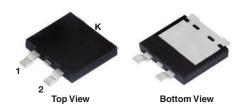
RoHS

COMPLIANT HALOGEN

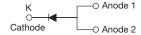
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Hyperfast Rectifier, 16 A FRED Pt®

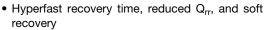


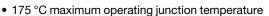
TO-263AC (SMPD)



PRODUCT SUMMARY				
Package	TO-263AC (SMPD)			
I _{F(AV)}	16 A			
V_{R}	200 V			
V _F at I _F	0.75 V			
t _{rr}	32 ns			
T _J max.	175 °C			
Diode variation	Single die			

FEATURES





- Specified for output and snubber operation
- · Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, telecom, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Peak repetitive reverse voltage	V_{RRM}		200	V	
Average rectified forward current	I _{F(AV)}	T _{solder pad} = 152 °C	16	۸	
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C, 6 ms square pulse	250	Α	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS MIN. TYP. MAX.		UNITS		
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-	
Faculty of the second state of the second stat		I _F = 16 A	-	0.91	1.0	V
Forward voltage	V _F	I _F = 16 A, T _J = 150 °C	-	0.75	0.84	
Reverse leakage current I _R		V _R = V _R rated	-	-	15	
		T _J = 150 °C, V _R = V _R rated	-	20	500	μΑ
Junction capacitance	C _T	V _R = 200 V	-	60	-	pF

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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS
			$I_F = 1 \text{ A}, dI_F/dt = 50 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		32	-	
Deverage we appropriation a		I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		-	-	32	
Reverse recovery time	t _{rr}	T _J = 25 °C		-	26	-	ns
		T _J = 125 °C		-	40	-	
Dook recovery ourrent		T _J = 25 °C	$I_F = 16 \text{ A},$ $dI_F/dt = 200 \text{ A/}\mu\text{s},$ $V_R = 160 \text{ V}$	-	2.8	-	Α
Peak recovery current	IRRM	T _J = 125 °C		-	6	-	
B .	0	T _J = 25 °C		-	37	-	
neverse recovery charge	Reverse recovery charge Q _{rr}	T _J = 125 °C]	-	125	-	nC

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	+175	°C
Thermal resistance, junction to solder pad	R _{thJ-Sp}		-	1.1	1.5	°C/W
Approximate weight				0.55		g
Approximate weight				0.02		oz.
Marking device		Case style TO-263AC (SMPD)	16EDH02			

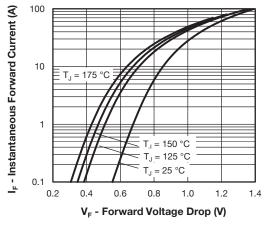


Fig. 1 - Typical Forward Voltage Drop Characteristics

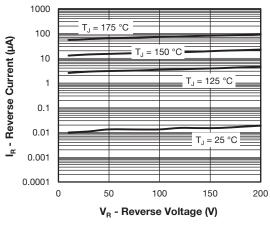


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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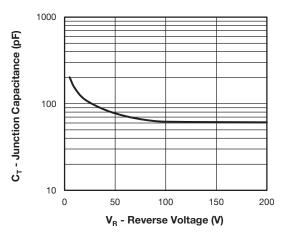


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

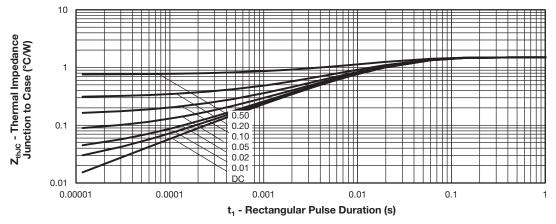


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

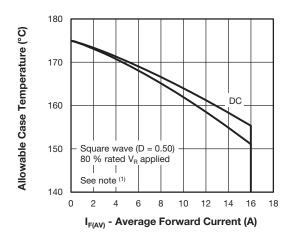


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

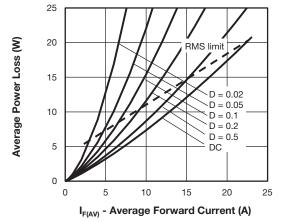


Fig. 6 - Forward Power Loss Characteristics

Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (\text{Pd} + \text{Pd}_{\text{REV}}) \times R_{\text{th,JC}}; \\ \text{Pd} = \text{Forward power loss} = I_{F(\text{AV})} \times V_{FM} \text{ at } (I_{F(\text{AV})}/D) \text{ (see fig. 5)}; \\ \text{Pd}_{\text{REV}} = \text{Inverse power loss} = V_{R1} \times I_{R} \text{ (1 - D); } I_{R} \text{ at } V_{R1} = \text{rated } V_{R} \\ \end{array}$

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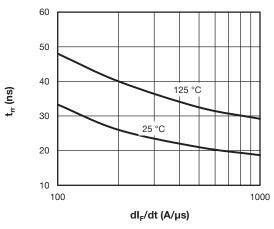


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt

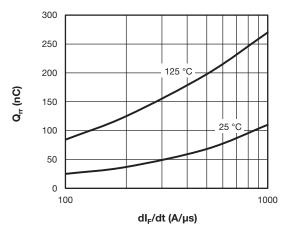
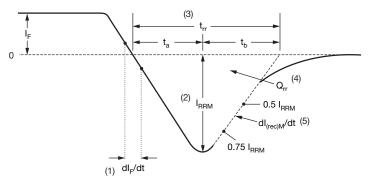


Fig. 8 - Typical Stored Charge vs. dl_F/dt



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_E to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (4) Q_{rr} area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions

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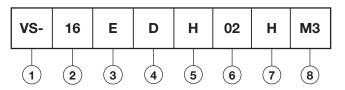
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ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product
- 2 Current rating (16 A)
- 3 Circuit configuration:
 - E = single die
- D = SMPD package
- **5** Process type,
 - H = hyperfast recovery
- 6 Voltage code (02 = 200 V)
- 7 H = AEC-Q101 qualified
- 8 M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N QUANTITY PER REEL MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION					
VS-16EDH02HM3/I	2000	2000	13" diameter plastic tape and reel		

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95604				
Part marking information	www.vishay.com/doc?95566			
Packaging information	www.vishay.com/doc?88869			



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